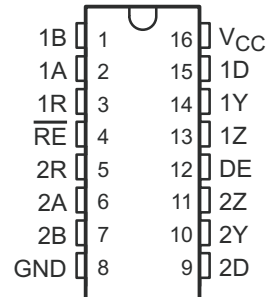
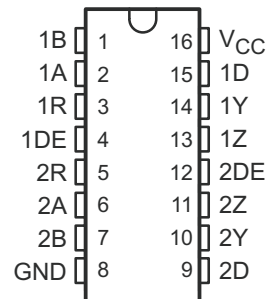


## DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

Check for Samples: [SN65C1167](#) [SN75C1167](#) [SN65C1168](#) [SN75C1168](#)

### FEATURES

- Meet or Exceed Standards TIA/EIA-422-B and ITU Recommendation V.11
- BiCMOS Process Technology
- Low Supply-Current Requirements: 9 mA Max
- Low Pulse Skew
- Receiver Input Impedance . . . 17 k $\Omega$  Typ
- Receiver Input Sensitivity . . .  $\pm 200$  mV
- Receiver Common-Mode Input Voltage Range of  $-7$  V to 7 V
- Operate From Single 5-V Power Supply
- Glitch-Free Power-Up/Power-Down Protection
- Receiver 3-State Outputs Active-Low Enable for SN65C1167 and SN75C1167 Only
- Improved Replacements for the MC34050 and MC34051

**SN65C1167 . . . DB OR NS PACKAGE  
SN75C1167 . . . DB, N, OR NS PACKAGE  
(TOP VIEW)**

**SN65C1168 . . . N, NS, OR PW PACKAGE  
SN75C1168 . . . DB, N, NS, OR PW PACKAGE  
(TOP VIEW)**


### DESCRIPTION

The SN65C1167, SN75C1167, SN65C1168, and SN75C1168 dual drivers and receivers are integrated circuits designed for balanced transmission lines. The devices meet TIA/EIA-422-B and ITU recommendation V.11.

The SN65C1167 and SN75C1167 combine dual 3-state differential line drivers and 3-state differential line receivers, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, which can be connected together externally to function as direction control. The SN65C1168 and SN75C1168 drivers have individual active-high enables.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE <sup>(1) (2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN75C1167N	SN75C1167N
			SN75C1168N	SN75C1168N
	SOP – NS	Tape and reel	SN75C1167NSR	75C1167
			SN75C1168NSR	75C1168
	SSOP – DB	Tape and reel	SN75C1167DBR	CA1167
			SN75C1168DBR	CA1168
	TSSOP – PW	Tube	SN75C1168PW	CA1168
		Tape and reel	SN75C1168PWR	
–40°C to 85°C	PDIP – N	Tube	SN65C1168N	SN65C1168N
			SN65C1167NSR	65C1167
	SOP – NS	Tape and reel	SN65C1168NSR	65C1168
			SN65C1167DBR	CB1167
	TSSOP – PW	Tube	SN65C1168PW	CB1168
		Tape and reel	SN65C1168PWR	

(1) Package drawings, thermal data, and symbolization are available at [www.ti.com/sc/packaging](http://www.ti.com/sc/packaging).

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

### FUNCTION TABLES

#### Each Driver<sup>(1)</sup>

INPUT D	ENABLE DE	OUTPUTS	
		Y	Z
H	H	H	L
L	H	L	H
X	L	Z	Z

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

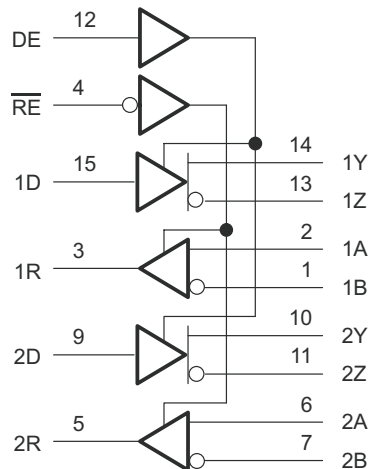
#### Each Receiver<sup>(1)</sup>

DIFFERENTIAL INPUTS A – B	ENABLE RE	OUTPUT R
$V_{ID} \geq 0.2\text{ V}$	L	H
$-0.2\text{ V} < V_{ID} < 0.2\text{ V}$	L	?
$V_{ID} \leq -0.2\text{ V}$	L	L
X	H	Z
Open	L	H

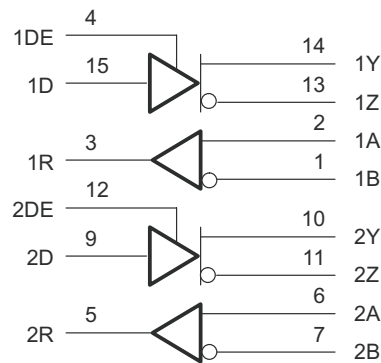
(1) H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off), Open = input disconnected or connected driver off

### LOGIC DIAGRAM (POSITIVE LOGIC)

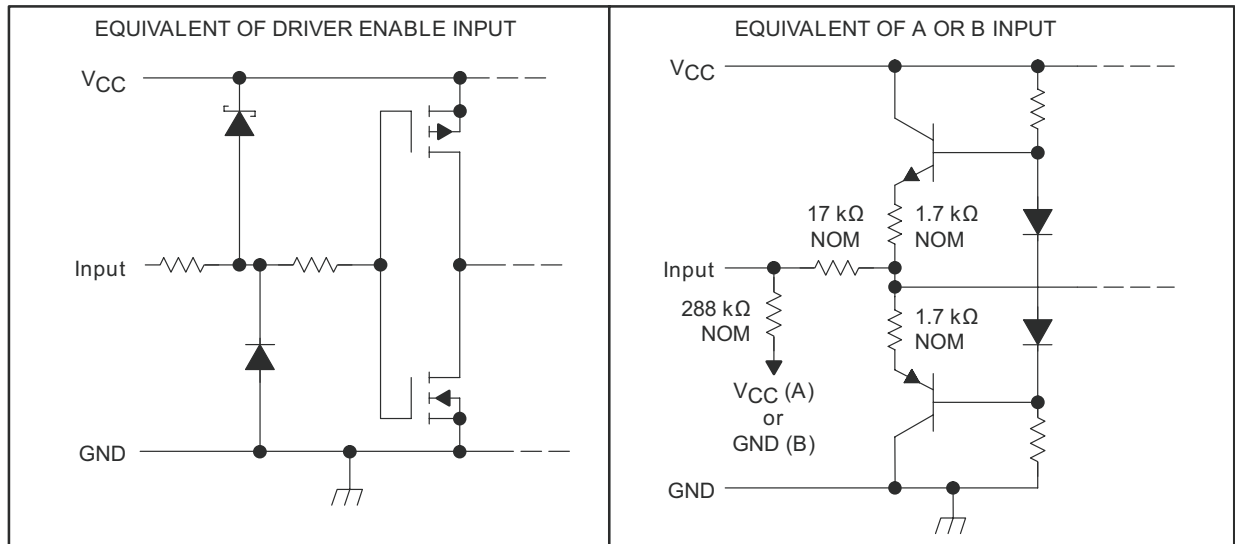
SN65C1167/SN75C1167



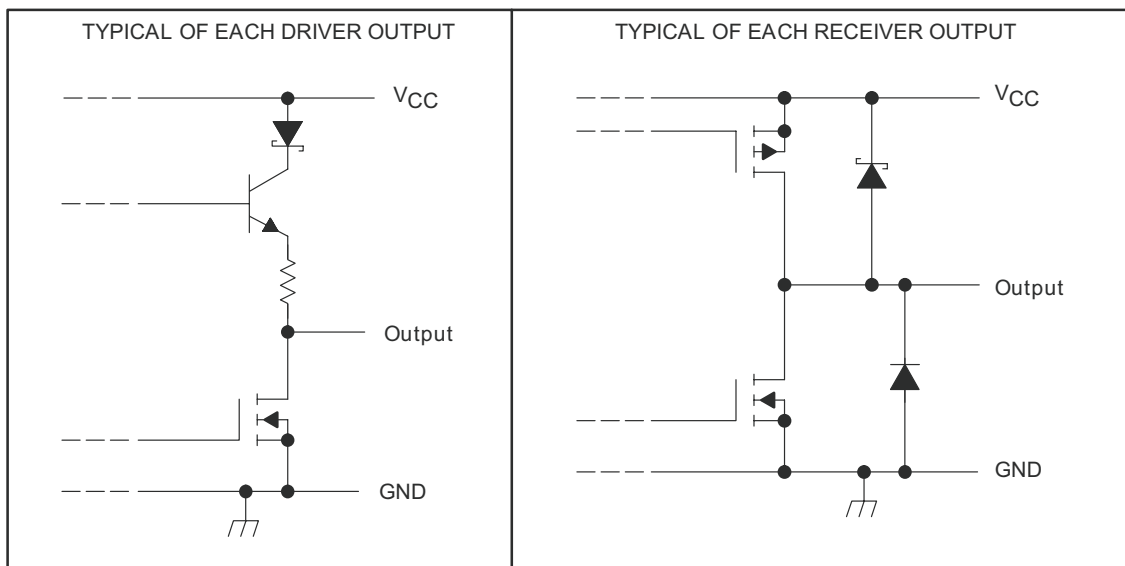
SN65C1168, SN75C1168



**SCHEMATIC OF INPUTS**



**SCHEMATIC OF OUTPUTS**



## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>	-0.5	7	V	
V <sub>I</sub>	Input voltage range	Driver	-0.5	V <sub>CC</sub> + 0.5	V
		A or B, Receiver	-11	14	
V <sub>ID</sub>	Differential input voltage range <sup>(3)</sup>	Receiver	-14	14	V
V <sub>O</sub>	Output voltage range	Driver	-0.5	7	V
I <sub>IK</sub> or I <sub>OK</sub>	Clamp current range	Driver		±20	mA
I <sub>O</sub>	Output current range	Driver		±150	mA
		Receiver		±25	
I <sub>CC</sub>	Supply current		200	mA	
	GND current		-200	mA	
T <sub>J</sub>	Operating virtual junction temperature		150	°C	
θ <sub>JA</sub>	Package thermal impedance <sup>(4) (5)</sup>	DB package		82	°C/W
		N package		67	
		NS package		64	
		PW package		108	
T <sub>stg</sub>	Storage temperature range	-65	150	°C	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages values except differential input voltage are with respect to the network GND.
- (3) Differential input voltage is measured at the noninverting terminal with respect to the inverting terminal.
- (4) Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> - T<sub>A</sub>)/θ<sub>JA</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (5) The package thermal impedance is calculated in accordance with JESD 51-7.

## RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	V
V <sub>IC</sub>	Common-mode input voltage <sup>(1)</sup>	Receiver		±7	V
V <sub>ID</sub>	Differential input voltage	Receiver		±7	V
V <sub>IH</sub>	High-level input voltage	Except A, B	2		V
V <sub>IL</sub>	Low-level input voltage	Except A, B		0.8	V
I <sub>OH</sub>	High-level output current	Receiver		-6	mA
		Driver		-20	
I <sub>OL</sub>	Low-level output current	Receiver		6	mA
		Driver		20	
T <sub>A</sub>	Operating free-air temperature	SN75C1167, SN75C1168	0	70	°C
		SN65C1167, SN65C1168	-40	85	

- (1) Refer to TIA/EIA-422-B for exact conditions.

## DRIVER SECTION

### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(2)</sup>	MAX	UNIT	
V <sub>IK</sub>	Input clamp voltage	I <sub>I</sub> = -18 mA				-1.5	V	
V <sub>OH</sub>	High-level output voltage	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -20 mA	2.4	3.4		V	
V <sub>OL</sub>	Low-level output voltage	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA		0.2	0.4	V	
V <sub>OD1</sub>	Differential output voltage	I <sub>O</sub> = 0 mA		2		6	V	
V <sub>OD2</sub>	Differential output voltage <sup>(1)</sup>	R <sub>L</sub> = 100 Ω, See <a href="#">Figure 1</a>		2	3.1		V	
Δ V <sub>OD</sub>	Change in magnitude of differential output voltage					±0.4	V	
V <sub>OCC</sub>	Common-mode output voltage						±3	V
Δ V <sub>OCC</sub>	Change in magnitude of common-mode output voltage						±0.4	V
I <sub>O(OFF)</sub>	Output current with power off	V <sub>CC</sub> = 0 V	V <sub>O</sub> = 6 V V <sub>O</sub> = -0.25 V			100 -100	μA	
I <sub>OZ</sub>	High-impedance-state output current	V <sub>O</sub> = 2.5 V V <sub>O</sub> = 5 V				20 -20	μA	
I <sub>IH</sub>	High-level input current	V <sub>I</sub> = V <sub>CC</sub> or V <sub>IH</sub>				1	μA	
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> = GND or V <sub>IL</sub>				-1	μA	
I <sub>OS</sub>	Short-circuit output current <sup>(3)</sup>	V <sub>O</sub> = V <sub>CC</sub> or GND,		-30		-150	mA	
I <sub>CC</sub>	Supply current (total package) <sup>(4)</sup>	No load, Enabled	V <sub>I</sub> = V <sub>CC</sub> or GND V <sub>I</sub> = 2.4 or 0.5 V		4 5	6 3	mA	
C <sub>i</sub>	Input capacitance				6		pF	

(1) Refer to TIA/EIA-422-B for exact conditions.

(2) All typical values are at V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(3) Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

(4) This parameter is measured per input, while the other inputs are at V<sub>CC</sub> or GND.

### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(1)</sup>	MAX	UNIT
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	R1 = R2 = 50 Ω, C1 = C2 = C3 = 40 pF, See <a href="#">Figure 2</a>	R3 = 500 Ω, S1 is open,		7	12	ns
t <sub>PLH</sub>	Propagation delay time, low- to high-level output				7	12	ns
t <sub>sk(p)</sub>	Pulse skew				0.5	4	ns
t <sub>r</sub>	Rise time	R1 = R2 = 50 Ω, C1 = C2 = C3 = 40 pF, See <a href="#">Figure 3</a>	R3 = 500 Ω, S1 is open,		5	10	ns
t <sub>f</sub>	Fall time				5	10	ns
t <sub>PZH</sub>	Output enable time to high level	R1 = R2 = 50 Ω, C1 = C2 = C3 = 40 pF, See <a href="#">Figure 4</a>	R3 = 500 Ω, S1 is closed,		10	19	ns
t <sub>PZL</sub>	Output enable time to low level				10	19	ns
t <sub>PHZ</sub>	Output disable time from low level	R1 = R2 = 50 Ω, C1 = C2 = C3 = 40 pF, See <a href="#">Figure 4</a>	R3 = 500 Ω, S1 is closed,		7	16	ns
t <sub>PLZ</sub>	Output disable time from high level				7	16	ns

(1) All typical values are at V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

## RECEIVER SECTION

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(1)</sup>	MAX	UNIT
$V_{IT+}$	Positive-going input threshold voltage, differential input					0.2	V
$V_{IT-}$	Negative-going input threshold voltage, differential input			-0.2 <sup>(2)</sup>			V
$V_{hys}$	Input hysteresis ( $V_{IT+} - V_{IT-}$ )				60		mV
$V_{IK}$	Input clamp voltage, $\overline{RE}$	SN75C1167	$I_I = -18$ mA			-1.5	V
$V_{OH}$	High-level output voltage	$V_{ID} = 200$ mV, $I_{OH} = -6$ mA		3.8	4.2		V
$V_{OL}$	Low-level output voltage	$V_{ID} = -200$ mV, $I_{OL} = 6$ mA			0.1	0.3	V
$I_{OZ}$	High-impedance-state output current	SN75C1167	$V_O = V_{CC}$ or GND		$\pm 0.5$	$\pm 5$	$\mu$ A
$I_I$	Line input current		Other input at 0 V			1.5	mA
						-2.5	
$I_I$	Enable input current, $\overline{RE}$	SN75C1167	$V_I = V_{CC}$ or GND			$\pm 1$	$\mu$ A
$r_i$	Input resistance	$V_{IC} = -7$ V to 7 V, Other input at 0 V		4	17		k $\Omega$
$I_{CC}$	Supply current (total package)		No load, Enabled	$V_I = V_{CC}$ or GND		4	6
				$V_{IH} = 2.4$ V or 0.5 V <sup>(3)</sup>		5	9

(1) All typical values are at  $V_{CC} = 5$  V and  $T_A = 25^\circ$ C.

(2) The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

(3) Refer to TIA/EIA-422-B for exact conditions.

### Switching Characteristics

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(2)</sup>	MAX	UNIT
$t_{PLH}$	Propagation delay time, low- to high-level output	See Figure 5		9	17	27	ns
$t_{PHL}$	Propagation delay time, high- to low-level output			9	17	27	ns
$t_{TLH}$	Transition time, low- to high-level output	$V_{IC} = 0$ V, See Figure 5			4	9	ns
$t_{THL}$	Transition time, high- to low-level output				4	9	ns
$t_{PZH}$	Output enable time to high level	$R_L = 1$ kW, See Figure 6			13	22	ns
$t_{PZL}$	Output enable time to low level				13	22	ns
$t_{PHZ}$	Output disable time from high level				13	22	ns
$t_{PLZ}$	Output disable time from low level				13	22	ns

(1) Measured per input while the other inputs are at  $V_{CC}$  or GND

(2) All typical values are at  $V_{CC} = 5$  V and  $T_A = 25^\circ$ C.

PARAMETER MEASUREMENT INFORMATION

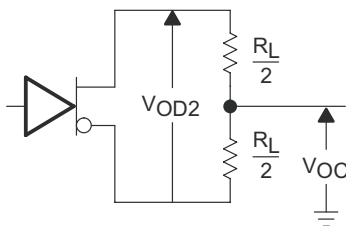


Figure 1. Driver Test Circuit,  $V_{OD}$  and  $V_{OC}$

- A. C1, C2, and C3 include probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_r = t_f \leq 6$  ns.

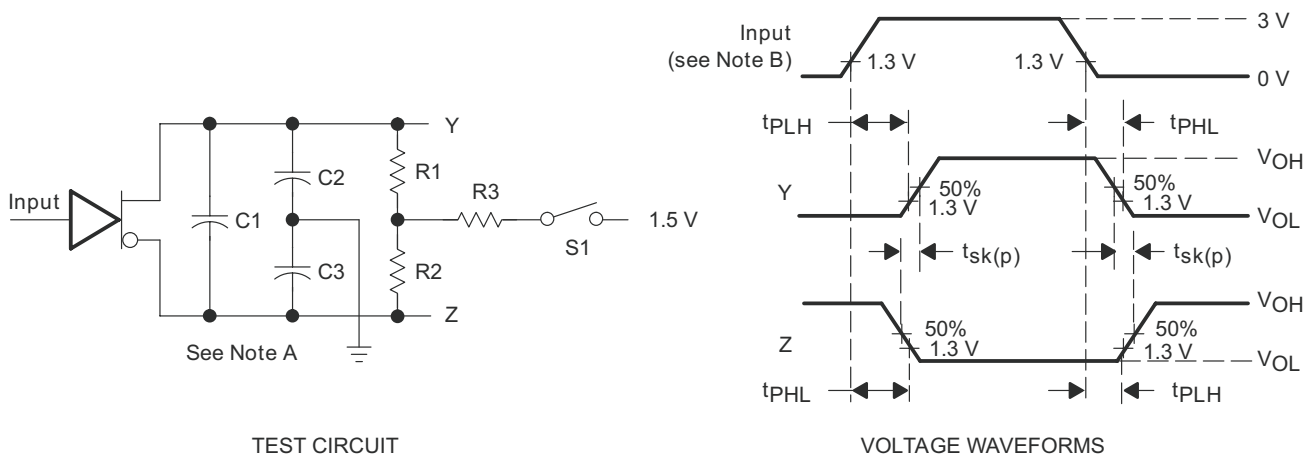


Figure 2. Driver Test Circuit and Voltage Waveforms

- C. C1, C2, and C3 include probe and jig capacitance.
- D. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_r = t_f \leq 6$  ns.

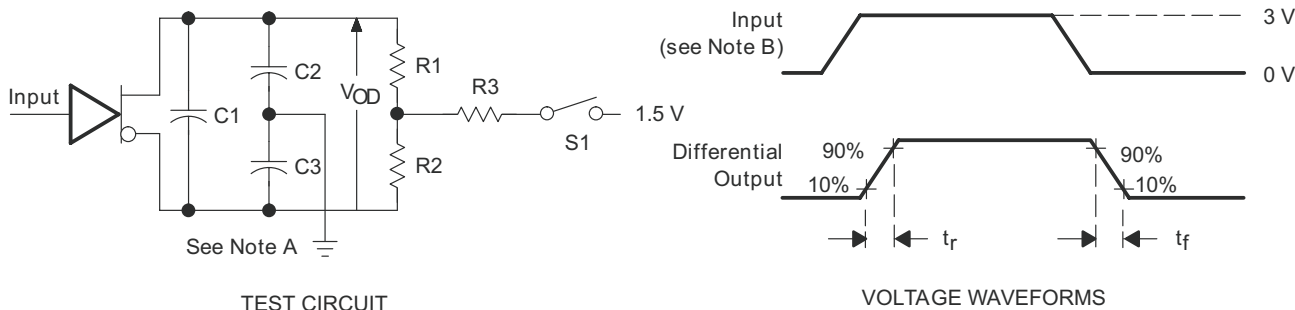


Figure 3. Driver Test Circuit and Voltage Waveforms

- E. C1, C2, and C3 include probe and jig capacitance.
- F. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_r = t_f \leq 6$  ns.



PARAMETER MEASUREMENT INFORMATION (continued)

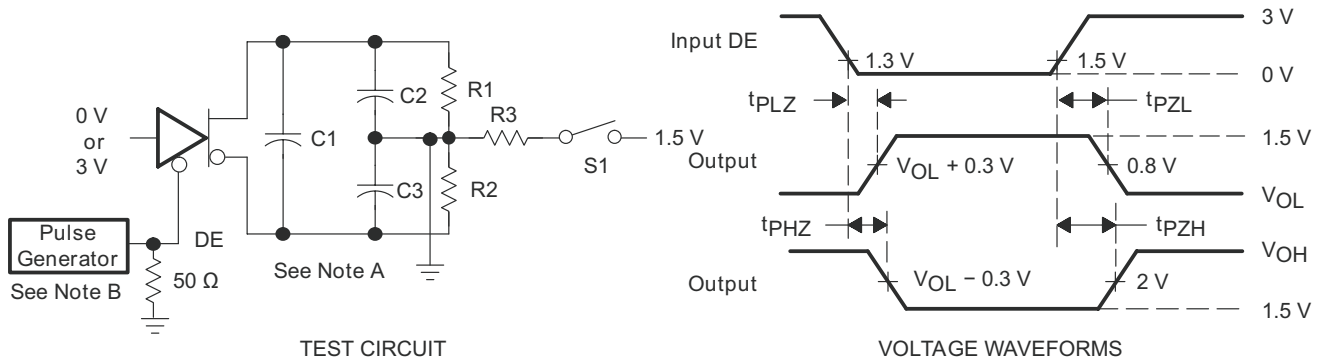


Figure 4. Driver Test Circuit and Voltage Waveforms

- G.  $C_L$  includes probe and jig capacitance.
- H. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_r = t_f \leq 6$  ns.

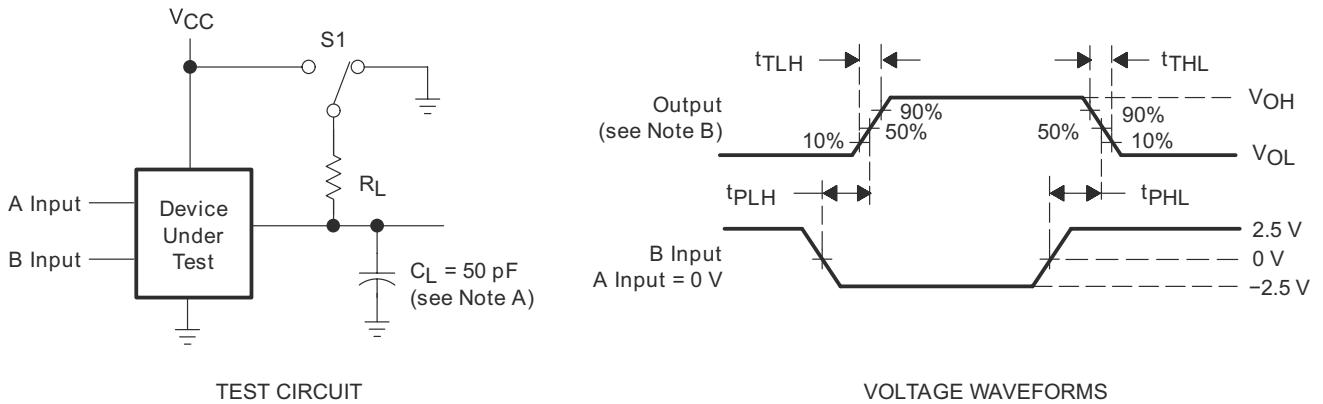


Figure 5. Receiver Test Circuit and Voltage Waveforms

- I.  $C_L$  includes probe and jig capacitance.
- J. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_r = t_f \leq 6$  ns.

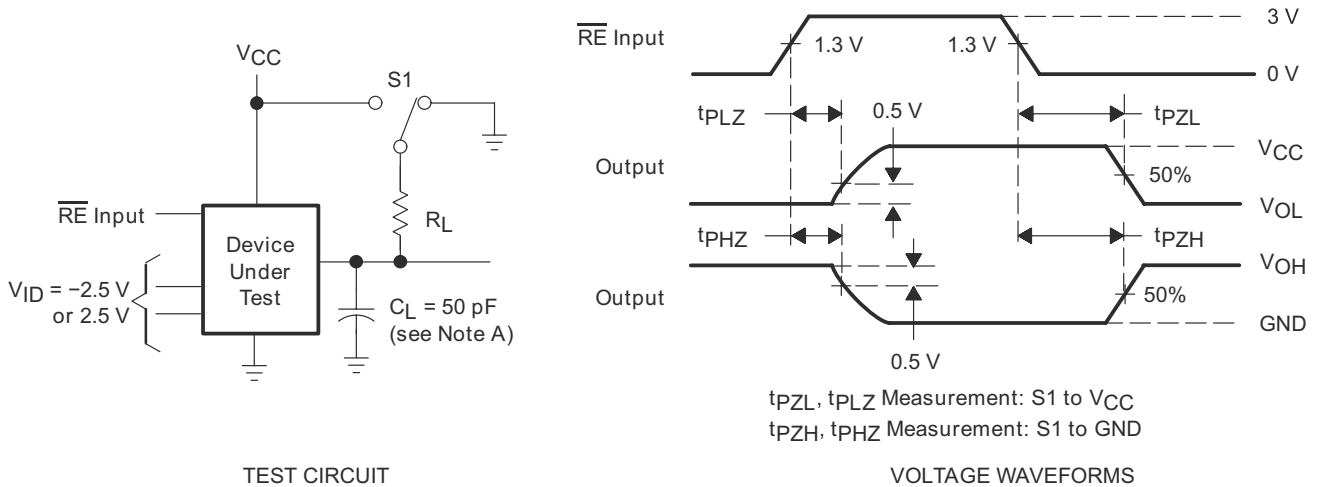


Figure 6. Receiver Test Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN65C1167NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65C1167	<a href="#">Samples</a>
SN65C1167NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65C1167	<a href="#">Samples</a>
SN65C1168N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	SN65C1168N	<a href="#">Samples</a>
SN65C1168NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65C1168	<a href="#">Samples</a>
SN65C1168NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65C1168	<a href="#">Samples</a>
SN65C1168PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	CB1168	<a href="#">Samples</a>
SN65C1168PWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	CB1168	<a href="#">Samples</a>
SN65C1168PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	CB1168	<a href="#">Samples</a>
SN75C1167DBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1167	<a href="#">Samples</a>
SN75C1167N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75C1167N	<a href="#">Samples</a>
SN75C1167NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75C1167	<a href="#">Samples</a>
SN75C1167NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75C1167	<a href="#">Samples</a>
SN75C1168DBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>
SN75C1168N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75C1168N	<a href="#">Samples</a>
SN75C1168NE4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75C1168N	<a href="#">Samples</a>
SN75C1168NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75C1168	<a href="#">Samples</a>
SN75C1168NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75C1168	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN75C1168PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>
SN75C1168PWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>
SN75C1168PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>
SN75C1168PWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>
SN75C1168PWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	CA1168	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65C1167NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN65C1168NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN65C1168PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN75C1167DBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
SN75C1168DBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
SN75C1168PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN65C1167NSR	SO	NS	16	2000	367.0	367.0	38.0
SN65C1168NSR	SO	NS	16	2000	367.0	367.0	38.0
SN65C1168PWR	TSSOP	PW	16	2000	367.0	367.0	35.0
SN75C1167DBR	SSOP	DB	16	2000	367.0	367.0	38.0
SN75C1168DBR	SSOP	DB	16	2000	367.0	367.0	38.0
SN75C1168PWR	TSSOP	PW	16	2000	367.0	367.0	35.0



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NOTES:

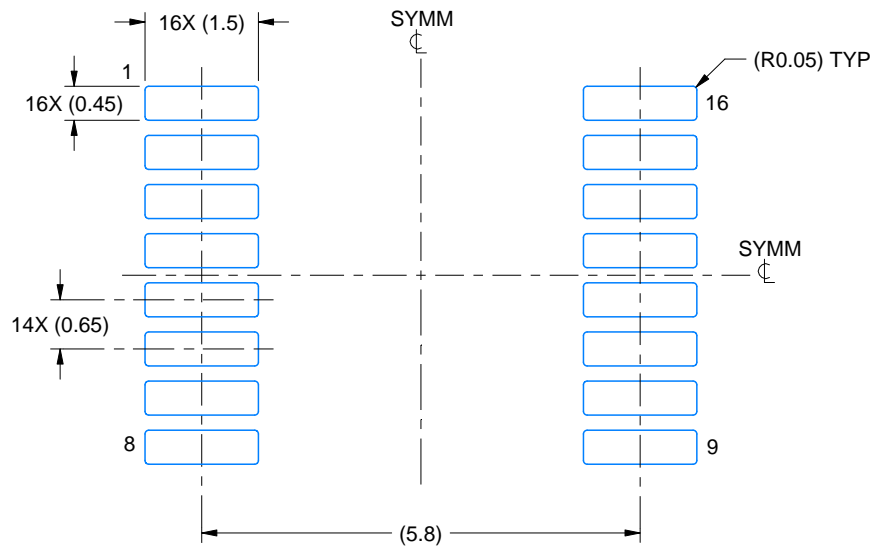
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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